

Unit in mm

Transistor Inverter

Inverter for Air Conditioner

IGBT Gate Drive

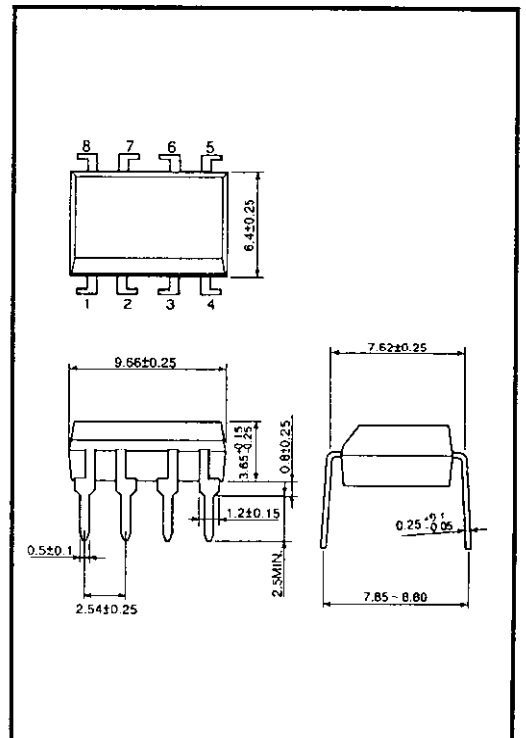
Power MOSFET Gate Drive

The Toshiba TLP250 consists of a GaAs light emitting diode and an integrated photodetector. This unit is in an 8-lead DIP package. TLP250 is suitable for the gate driving circuit of an IGBT or power MOSFET.

- Input Threshold Current : $I_F = 5\text{mA}$ (Max.)
- Supply Current (I_{CC}) : 11mA (Max.)
- Supply Voltage (V_{CC}) : $10\text{-}35\text{V}$
- Output Current (I_O) : $\pm 0.5\text{A}$ (Min.)
- Switching Time (t_{pLH}/t_{pHL}) : $0.5\mu\text{s}$ (Max.)
- Isolation Voltage : $2500V_{rms}$ (Min.)
- UL Recognized : UL1577, File No. E67349

(Note) When a VDE0884 approved type is needed, please designate the "Option (D4)"

- Option (D4) type
VDE Approved: DIN VDE0884/06.92, Certificate No. 76823
Maximum Operating Insulation Voltage: $630 V_{PK}$
Highest Permissible Over Voltage : $4000 V_{PK}$
- Creepage Distance : 6.4mm (Min.)
Clearance : 6.4mm (Min.)



JEDEC	—
EIAJ	—
TOSHIBA	11-10C4

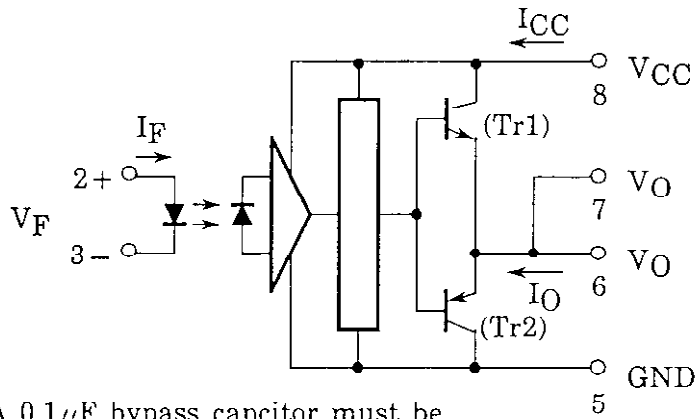
Weight : 0.54g

Supplementary Information	Page (s)
Lead Form Options	31-32
Tape and Reel	39-40

The information contained here is subject to change without notice.

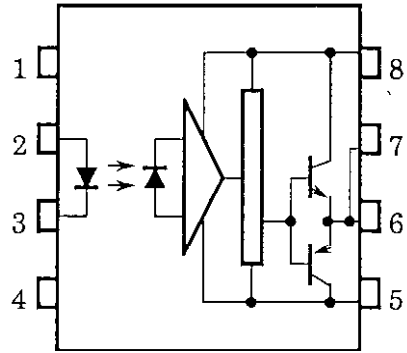
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Schematic



A $0.1\mu\text{F}$ bypass capacitor must be connected between pin 8 and 5 (See more 5).

Pin Configuration (Top View)



- 1 : N.C.
- 2 : ANODE
- 3 : CATHODE
- 4 : N.C.
- 5 : GND
- 6 : V_O (OUTPUT)
- 7 : V_O
- 8 : V_{CC}

Truth Table

		Tr1	Tr2
Input LED	ON	ON	OFF
	OFF	OFF	ON

Absolute Maximum Ratings (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT	
LED	Forward Current	I_F	20	mA	
	Forward Current Derating (Ta ≥ 70°C)	$\Delta I_F/\Delta T_a$	-0.36	mA/°C	
	Peak Transient Forward Current (Note 1)	I_{PFT}	1	A	
	Reverse Voltage	V_R	5	V	
	Junction Temperature	T_j	125	°C	
DETECTOR	"H" Peak Output Current ($P_W \leq 2.5\mu s$, $f \leq 15kHz$) (Note 2)	I_{OPH}	-1.5	A	
	"L" Peak Output Current ($P_W \leq 2.5\mu s$, $f \leq 15kHz$) (Note 2)	I_{OPL}	+1.5	A	
	Output Voltage	(Ta ≤ 70°C)	V_O	35	V
		(Ta = 85°C)		24	
	Supply Voltage	(Ta ≤ 70°C)	V_{CC}	35	V
		(Ta = 85°C)		24	
	Output Voltage Derating (Ta ≥ 70°C)		$\Delta V_O/\Delta T_a$	-0.73	V/°C
	Supply Voltage Derating (Ta ≥ 70°C)		$\Delta V_{CC}/\Delta T_a$	-0.73	V/°C
Junction Temperature		(T_j)	125	°C	
Operating Frequency (Note 3)		f	25	kHz	
Operating Temperature Range		T_{opr}	-20~85	°C	
Storage Temperature Range		T_{stg}	-55~125	°C	
Lead Solder Temperature (10s)		T_{sol}	260	°C	
Isolation Voltage (AC, 1 min., R.H. ≤ 60%, Ta = 25°C) (Note 4)		BV_S	2500	V_{rms}	

Note 1: Pulse width $P_W \leq 1\mu s$, 300pps

Note 2: Exponential Waveform

Note 3: Exponential Waveform, $I_{OPH} \leq -1.0A$ ($\leq 2.5\mu s$), $I_{OPL} \leq +1.0A$ ($\leq 2.5\mu s$)

Note 4: Device considered a two terminal device: pins 1, 2, 3 and 4 shorted together, and pins 5, 6, 7 and 8 shorted together.

Note 5: A ceramic capacitor (0.1 μF) should be connected from pin 8 to pin 5 to stabilize the operation of the high gain linear amplifier. Failure to provide the bypassing may impair the switching property. The total lead length between capacitor and coupler should not exceed 1 cm.

Recommended Operating Conditions

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MX.		UNIT
Input Current, ON	$I_{F(ON)}$	7	8	10		mA
Input Voltage, OFF	$V_{F(OFF)}$	0	–	0.8		V
Supply Voltage	V_{CC}	15	–	30	20	V
Peak Output Current	I_{OPH}/I_{OPL}	–	–	±0.5		A
Operating Temperature	T_{opr}	-20	25	70	85	°C

Electrical Characteristics (Ta = -20~70°C, Unless otherwise specified)

CHARACTERISTIC		SYMBOL	TEST CIRCUIT	TEST CONDITION	MIN.	TYP.*	MX.	UNIT
Input Forward Voltage		V_F	–	$I_F = 10\text{mA}$, $T_a = 25^\circ\text{C}$	–	1.6	1.8	V
Temperature Coefficient of Forward Voltage		$\Delta V_F/\Delta T_a$	–	$I_F = 10\text{mA}$	–	-2.0	–	mV/°C
Input Reverse Current		I_R	–	$V_R = 5\text{V}$, $T_a = 25^\circ\text{C}$	–	–	10	μA
Input Capacitance		C_T	–	$V = 0$, $f = 1\text{MHz}$, $T_a = 25^\circ\text{C}$	–	45	250	pF
Output Current	“H” Level	I_{OPH}	3	$V_{CC} = 30\text{V}$ (*1)	$I_F = 10\text{mA}$ $V_{8-6} = 4\text{V}$	-0.5	-1.5	–
	“L” Level	I_{OPL}	2					
Output Voltage	“H” Level	V_{OH}	4	$V_{CC1} = +15\text{V}$, $V_{EE1} = -15\text{V}$ $R_L = 200\Omega$, $I_F = 5\text{mA}$	11	12.8	–	V
	“L” Level	V_{OL}	5	$V_{CC1} = +15\text{V}$, $V_{EE1} = -15\text{V}$ $R_L = 200\Omega$, $V_F = 0.8\text{V}$	–	-14.2	-12.5	
Supply Current	“H” Level	I_{CCH}	–	$V_{CC} = 30\text{V}$, $I_F = 10\text{mA}$ $T_a = 25^\circ\text{C}$	–	7	–	mA
				$V_{CC} = 30\text{V}$, $I_F = 10\text{mA}$	–	–	11	
	“L” Level	I_{CCL}	–	$V_{CC} = 30\text{V}$, $I_F = 0\text{mA}$ $T_a = 25^\circ\text{C}$	–	7.5	–	
				$V_{CC} = 30\text{V}$, $I_F = 0\text{mA}$	–	–	11	
Threshold Input Current	“Output L→H”	I_{FLH}	–	$V_{CC1} = +15\text{V}$, $V_{EE1} = -15\text{V}$ $R_L = 200\Omega$, $V_O \geq 0\text{V}$	–	1.2	5	mA
Threshold Input Voltage	“Output H→L”	V_{FHL}	–	$V_{CC1} = +15\text{V}$, $V_{EE1} = -15\text{V}$ $R_L = 200\Omega$, $V_O \leq 0\text{V}$	0.8	–	–	V
Supply Voltage		V_{CC}	–		10	–	35	V
Capacitance (Input-Output)		C_S	–	$V_S = 0$, $f = 1\text{MHz}$, $T_a = 25^\circ\text{C}$	–	1.0	2.0	pF
Resistance (Input-Output)		R_S	–	$V_S = 500\text{V}$, $T_a = 25^\circ\text{C}$, R.H.≤60%	5×10^{10}	10^{14}	–	Ω

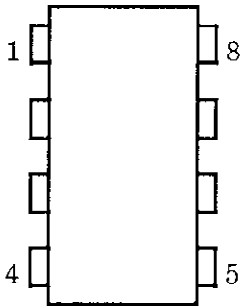
*All typical values are at $T_a = 25^\circ\text{C}$ (*1) : Duration of I_O time $\leq 50\mu\text{s}$

Switching Characteristics (Ta = -20~70°C, Unless otherwise specified)

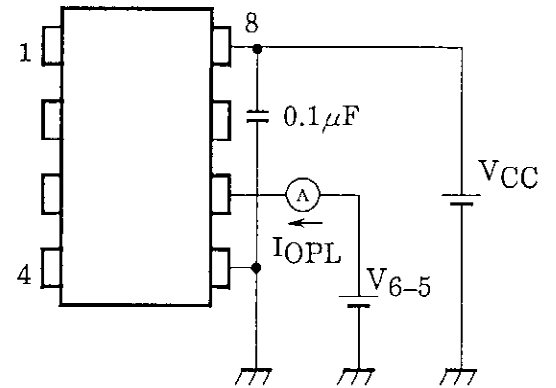
CHARACTERISTIC		SYMBOL	TEST CIRCUIT	TEST CONDITION	MIN.	TYP.*	MX.	UNIT	
Propagation Delay Time	L→H	t_{pLH}	6	$I_F = 8\text{mA}$ $V_{CC1} = +15\text{V}$, $V_{EE1} = -15\text{V}$ $R_L = 200\Omega$	–	0.15	0.5	μs	
	H→L	t_{pHL}			–	0.15	0.5		
Output Rise Time		t_r			–	–	–		–
Output Fall Time		t_f			–	–	–		–
Common Mode Transient Immunity at High Level Output		C_{MH}	7	$V_{CM} = 600\text{V}$, $I_F = 8\text{mA}$ $V_{CC} = 30\text{V}$, $T_a = 25^\circ\text{C}$	-5000	–	–	V/ μs	
Common Mode Transient Immunity at Low Level Output		C_{ML}	7	$V_{CM} = 600\text{V}$, $I_F = 0\text{mA}$ $V_{CC} = 30\text{V}$, $T_a = 25^\circ\text{C}$	5000	–	–	V/ μs	

*All typical values are at $T_a = 25^\circ\text{C}$

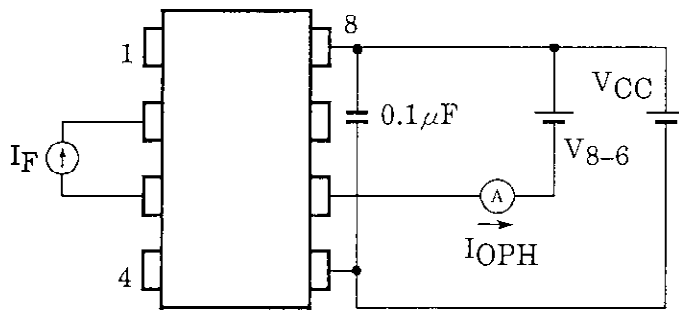
TEST CIRCUIT 1 :



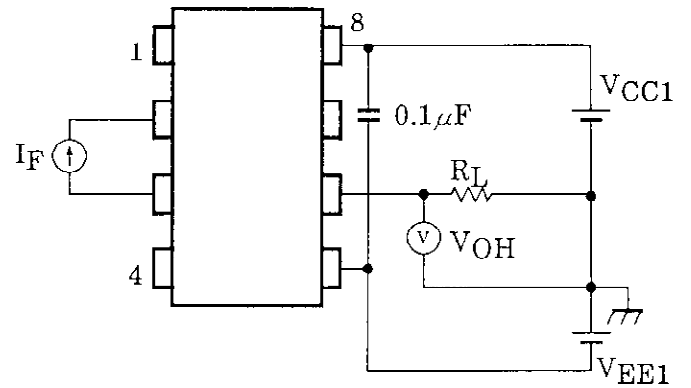
TEST CIRCUIT 2 : IOPL



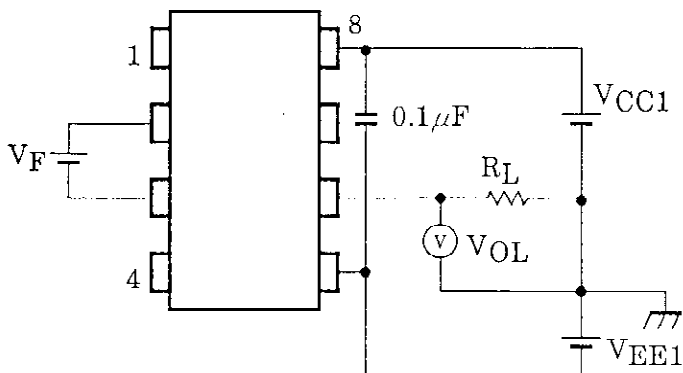
TEST CIRCUIT 3 : IOPH



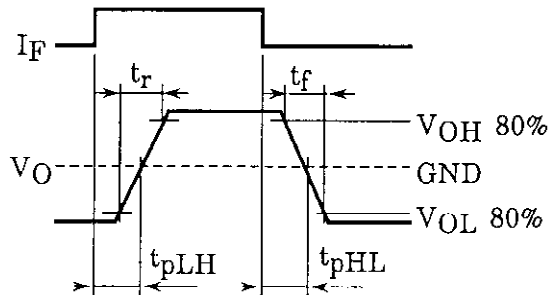
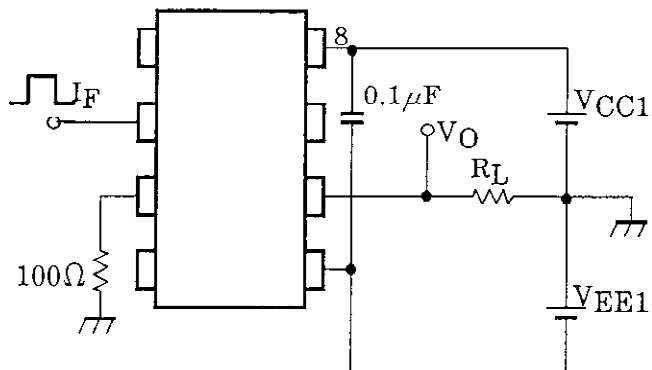
TEST CIRCUIT 4 : VOH



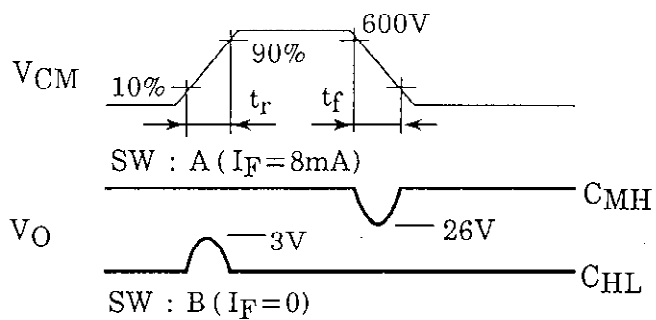
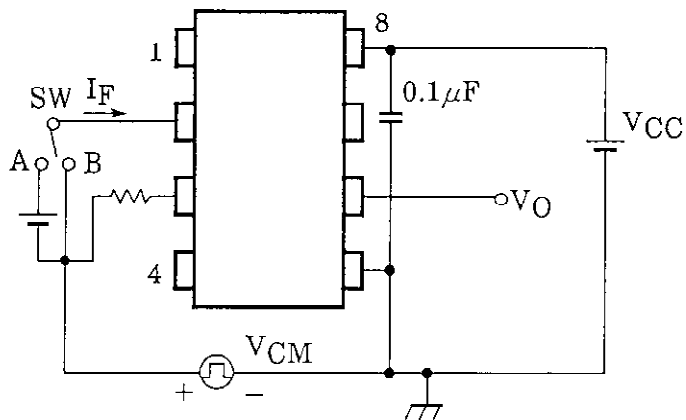
TEST CIRCUIT 5 : VOL



TEST CIRCUIT 6 : t_{pLH} , t_{pHL} , t_r , t_f



TEST CIRCUIT 7 : C_{MH} , C_{ML}



$$C_{ML} = \frac{480(V)}{t_r(\mu s)}$$

$$C_{MH} = \frac{480(V)}{t_f(\mu s)}$$

C_{ML} (C_{MH}) is the maximum rate of rise (fall) of the common mode voltage that can be sustained with the output voltage in the low (high) state.

